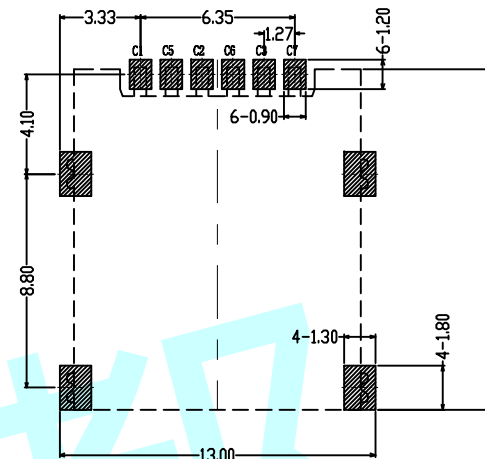
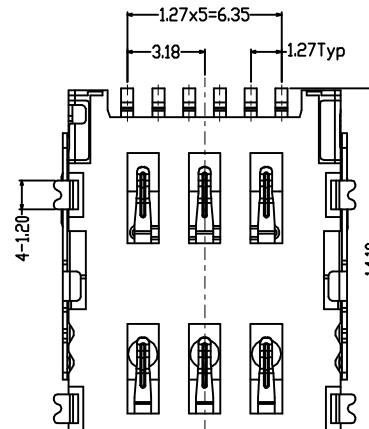
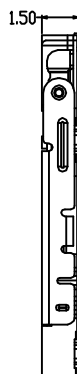
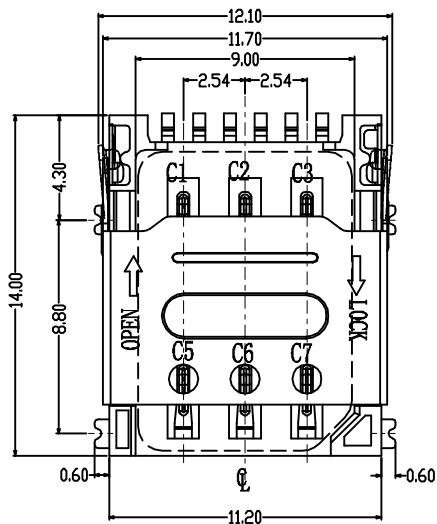
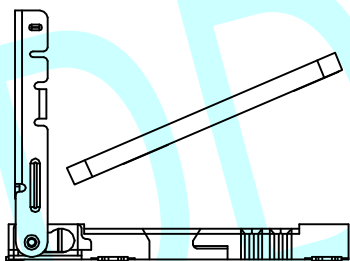
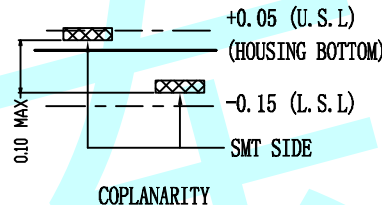


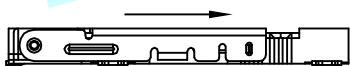
# ROHS



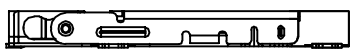
RECOMMENDED PCB LAYOUT  
GENERAL TOLERANCE  $\pm 0.05$



STEP 1 INSERT Micro-SIM CARD

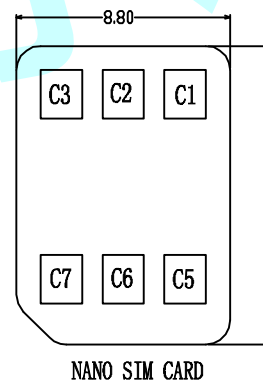


STEP 2 PUSH THE SHELL



STEP 3 FINISH

SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



NANO SIM CARD

NOTES:

A. ELECTRICAL CHARACTERISTICS:

- CONTACT RESISTANCE: 60m $\Omega$  Max
- INSULATION RESISTANCE: 1000M $\Omega$  Min
- VOLTAGE RATING: 50V
- CURRENT RATING: 1A

B. MECHANICAL CHARACTERISTICS:

- OPERATION TEMPERATURE RANGE: -20 $^{\circ}$ C~+85 $^{\circ}$ C
- DURABILITY: 5000 CYCLES

C. MATERIAL:


- HOUSING: THERMOPLASTIC, UL94V-0
- TERMINAL: PHOSPHOR BRONZE, T=0.15
- SHELL: STAINLESS STEEL, T=0.20

D. FINISHED:

- TERMINAL: Ni PLATED UNDER, 3U" Au MIN PLATED ON CONTACT AREA, AU PLATED ON SOLDER TAIL

APPROVALS		DATE	http://www.dongdudz.com	
DRAW:	ZRD	2017-12-6	TOLERANCE:	ANGLE:
CHECKED:	***	****	30 $\geq$	$\pm 2^{\circ}$
APPOVALS:	***	****	10 $\sim$ 30	
			5 $\sim$ 10	
			$\leq 5$	

 <b>东都电子</b> DONGDU ELECTRONICS	
MODEL:	USB CONNECTOR
PART NO:	NANO-SIM-6P
UNIT :mm	SCALE:1:1
REV:	A